# CMS MIP timing detector

# 中国物理学会高能物理分会第十一届全国会员代表大会暨学术年会

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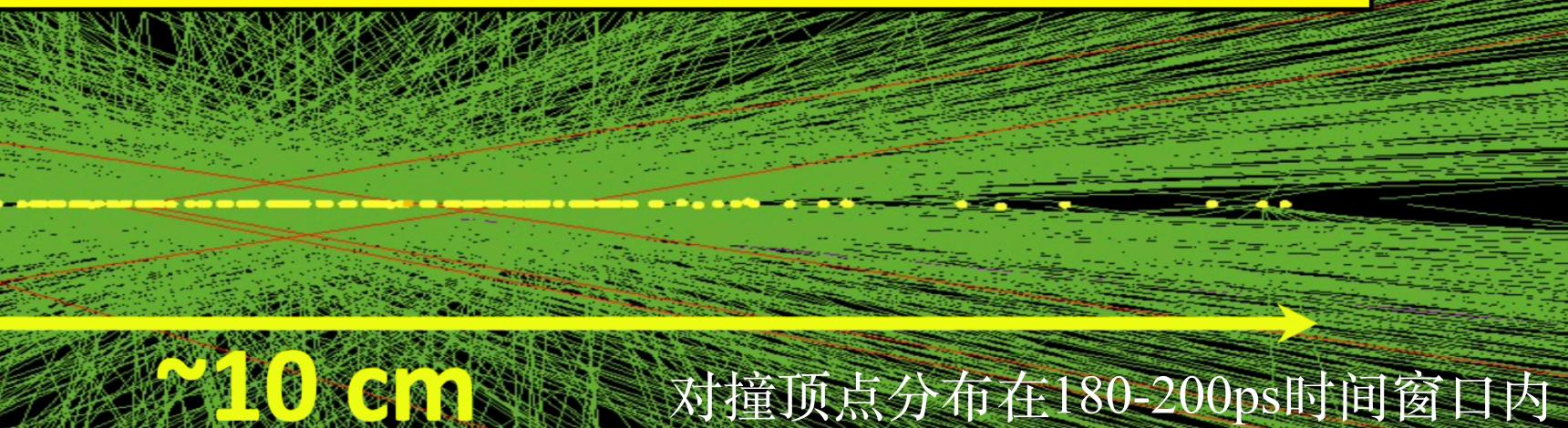
### $\mathbf{LHC} \to \mathbf{HL-LHC}$

- The LHC will be upgraded to HL-LHC in years

## HL-LHC升级后每次对撞产生近200个顶点

• 3-4x higher instantaneous luminosity, severe pileup (from 40~60 at LHC to 140~200 at HL-LHC), challenging both the precision measurements and the probe of new physics

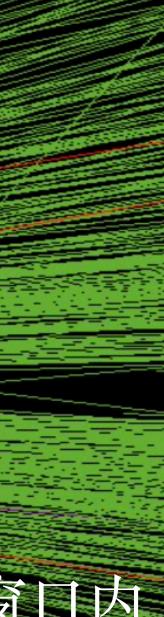
• To deal with this dense collision environment, a novel timing detector is proposed, MIP timing detector (MTD) for CMS, with an aim to reach 30 ps time resolution













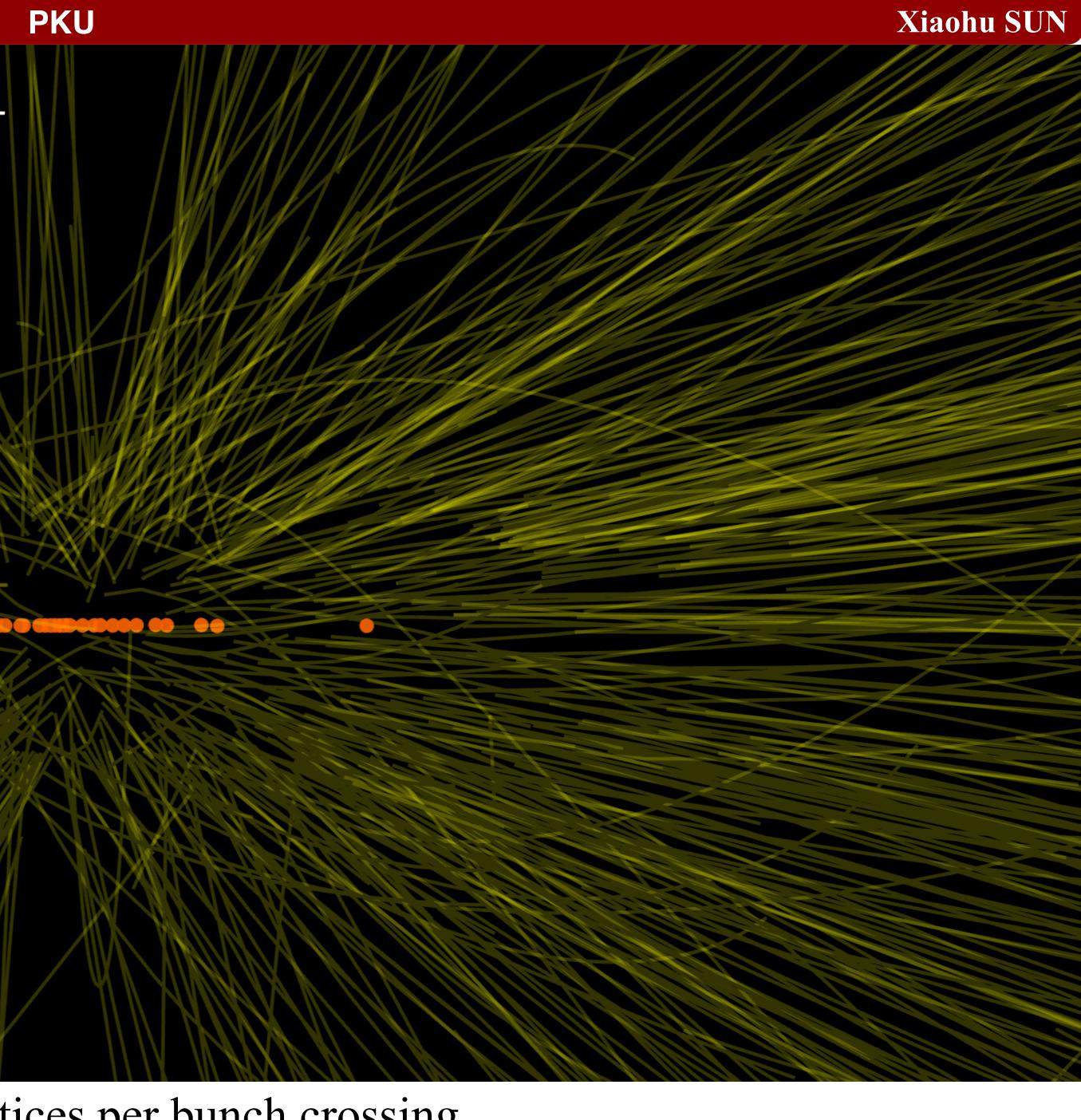


CMS Experiment at the LHC, CERN Data recorded: 2016-Aug-27 23:44:01.739584 GMT Run / Event / LS: 279685 / 178456860 / 95

### RUN 2: 40-60 vertices per bunch crossing

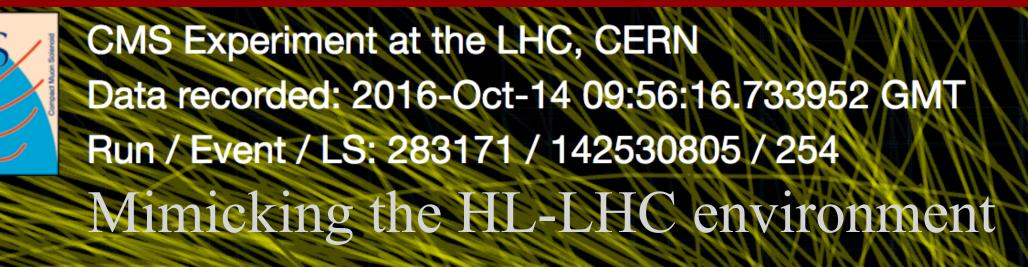






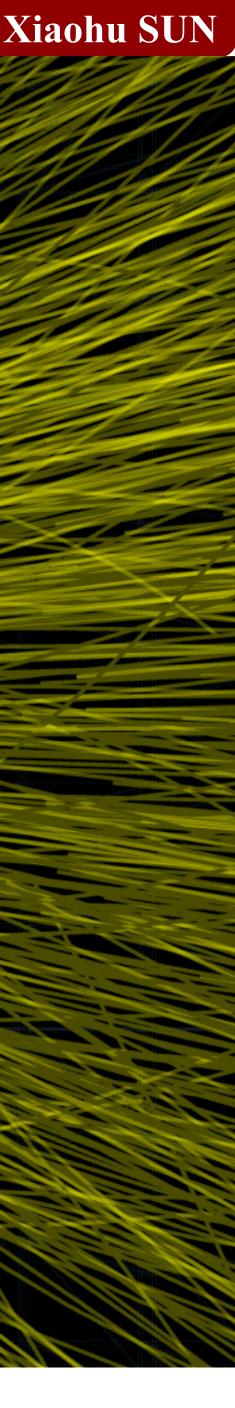


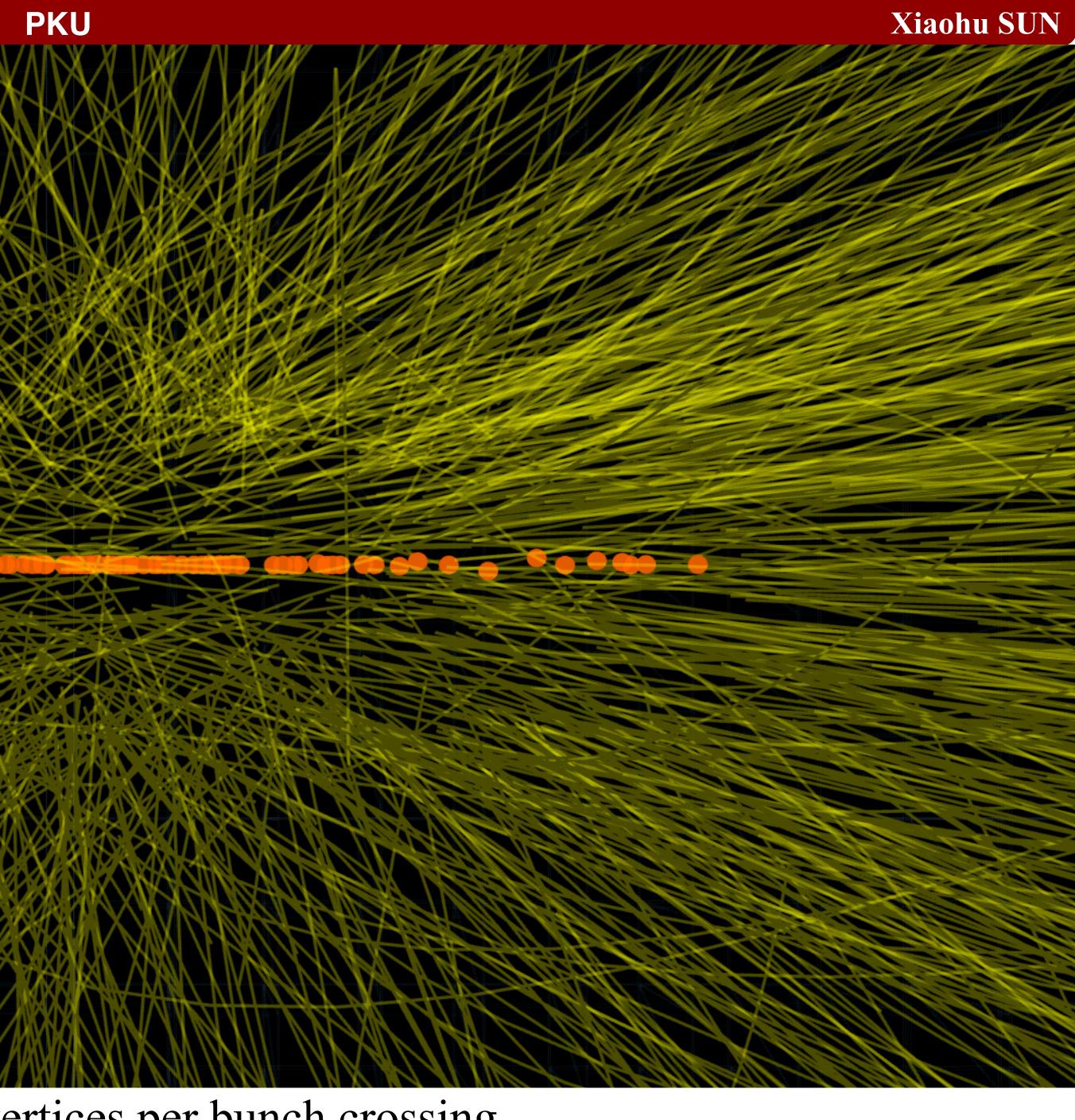
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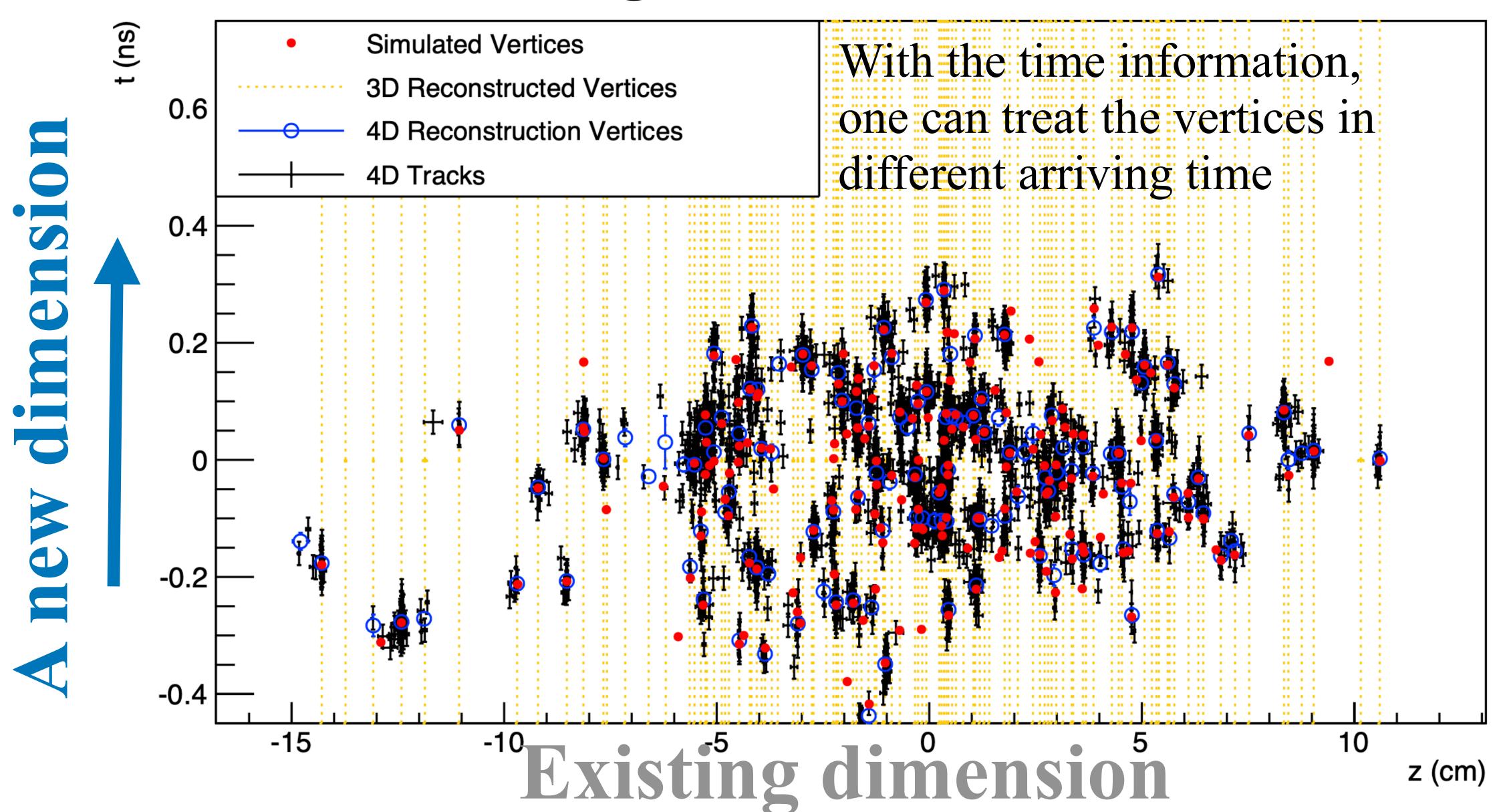
### HL-LHC: 140-200 vertices per bunch crossing







# MTD brings a new dimension



### **Peking University**





# MTD potential in physics

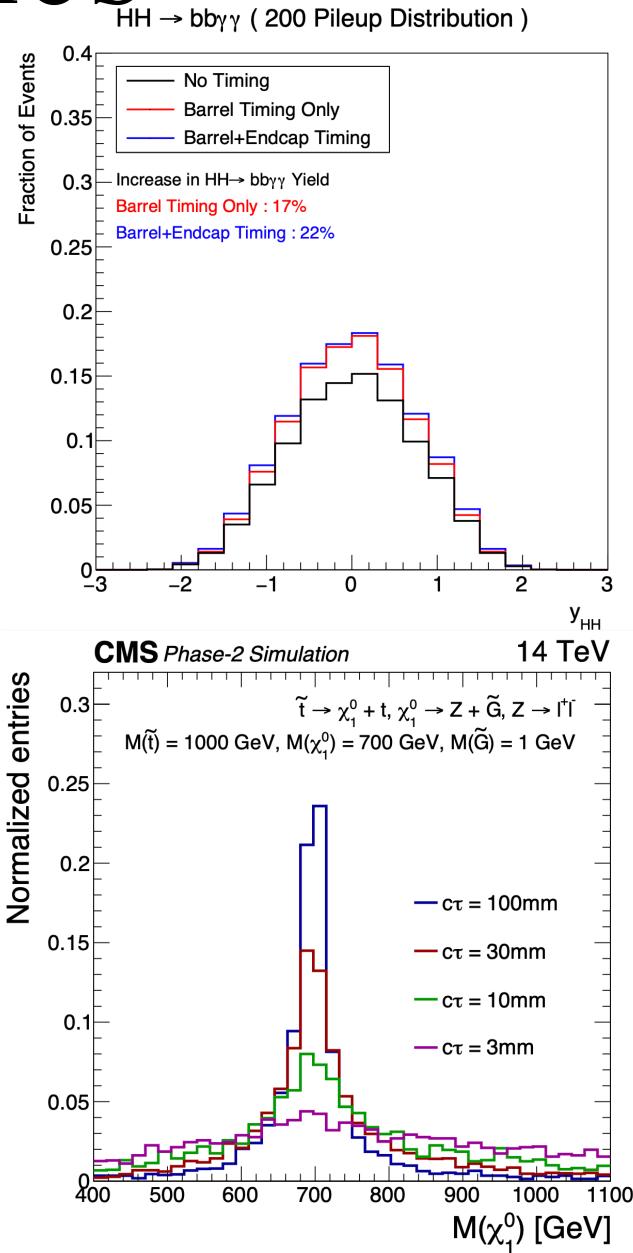
- MTD will effectively suppress the pileup effect and even bring new functionalities
  - Increase the HH signal acceptance by 20%

• Improve the single Higgs precision by 20-30%

• Suppress reducible background in SUSY by 40%

• Open a new avenue in searches for neutral LLPs

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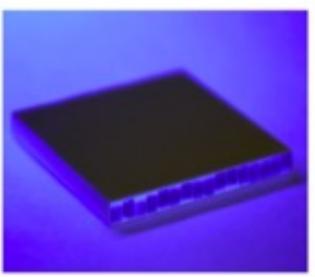


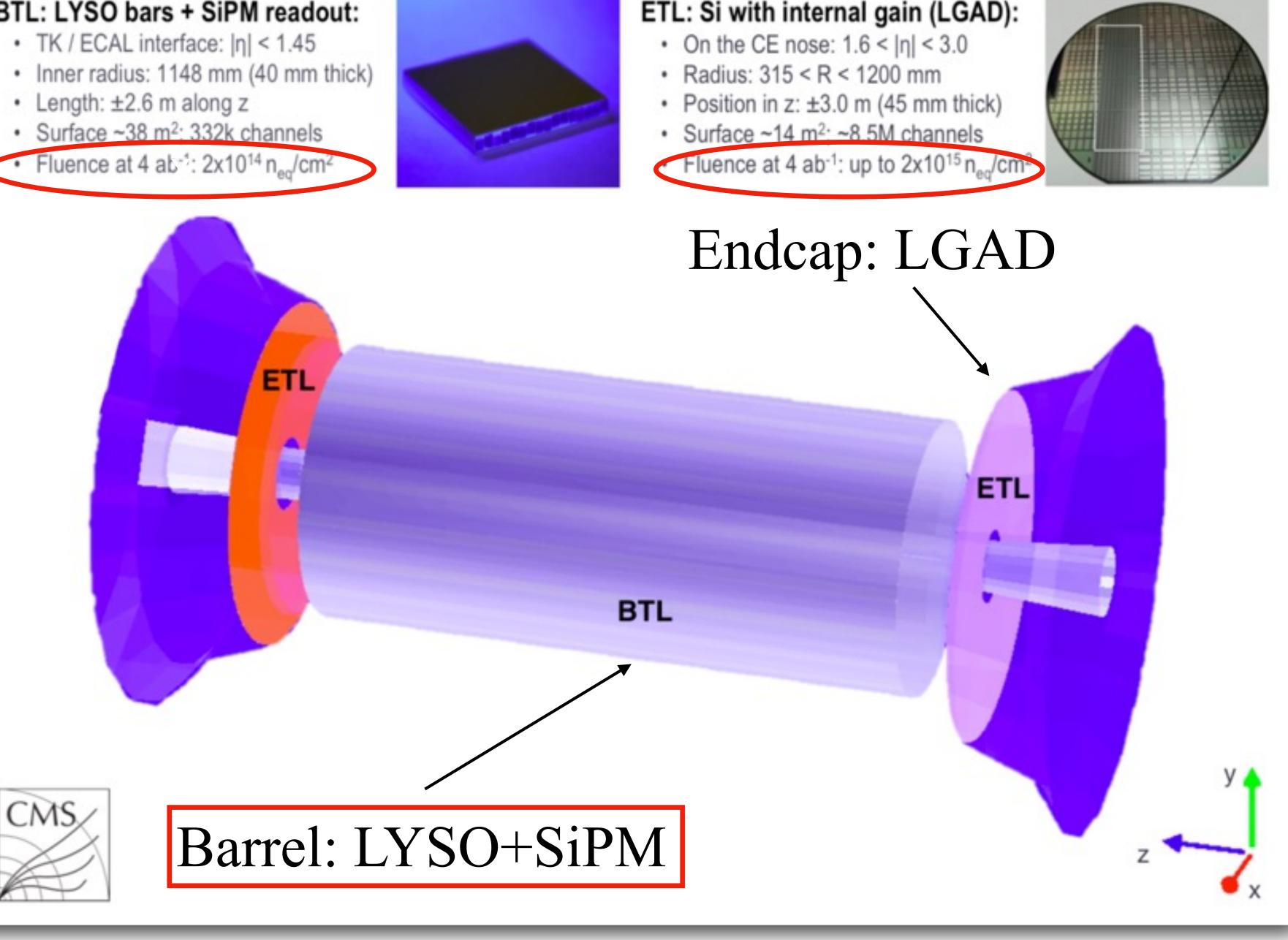
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### MTD

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### BTL: LYSO bars + SiPM readout:





### Layout

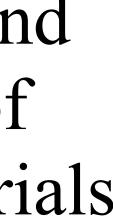
- In the barrel, LYSO+SiPM is adopted
- In the endcap, LGAD is adopted
- Very different radiation dose and different price of the sensor materials

• This talk will focus on MTD BTL

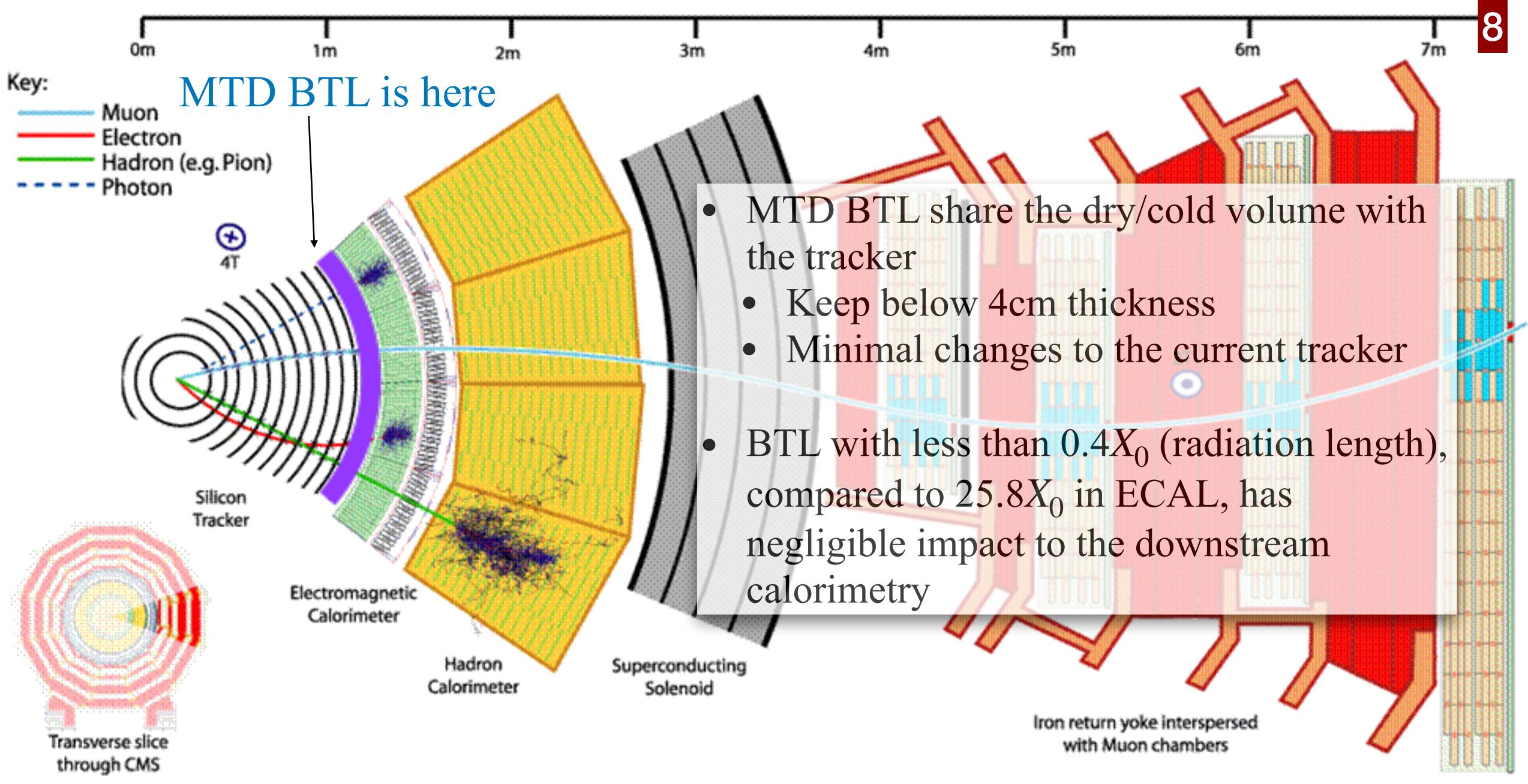






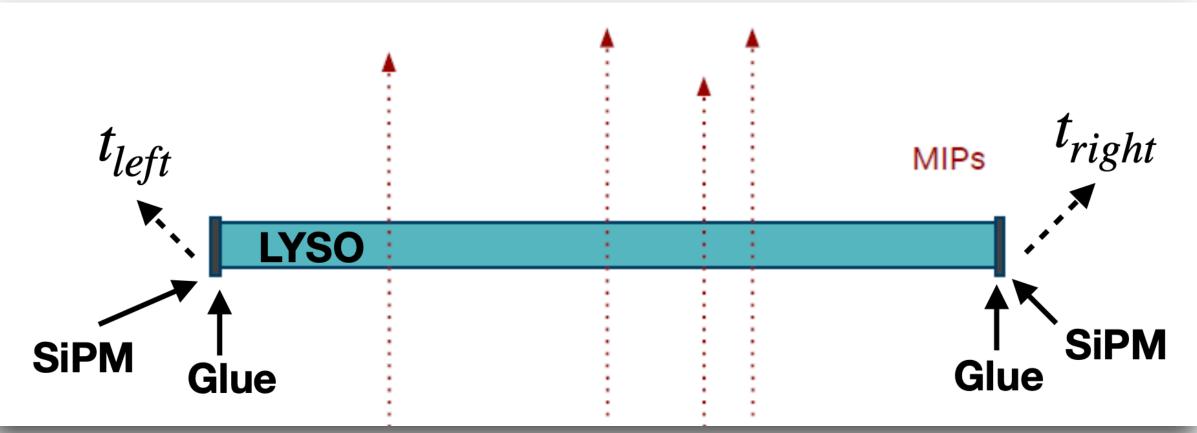








### Sensor: LYSO

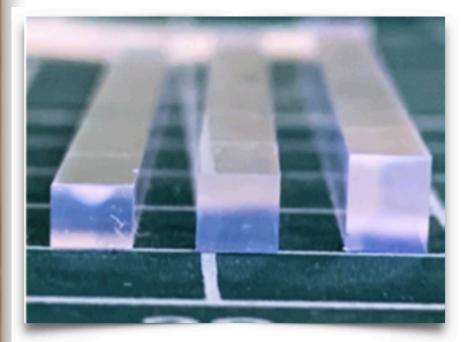


### 16 LYSO crystals

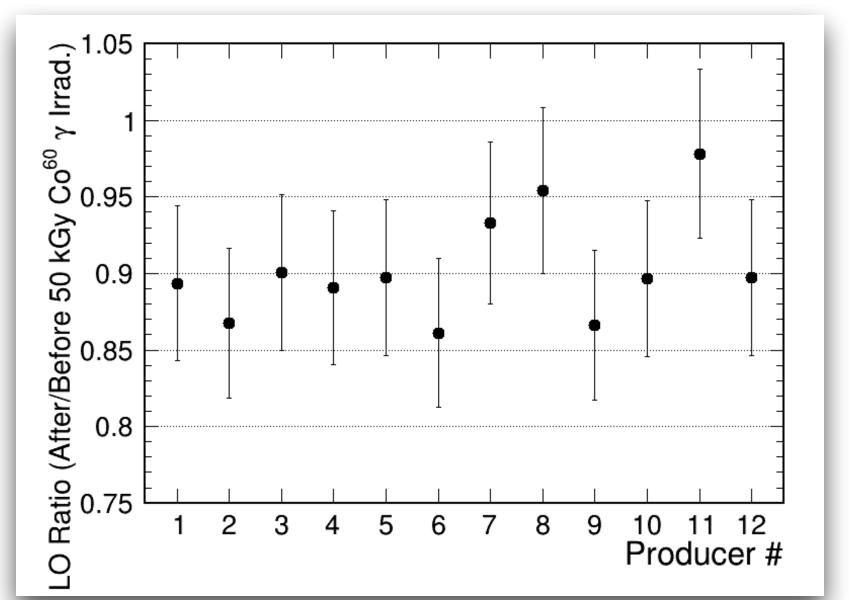
### Sensor module

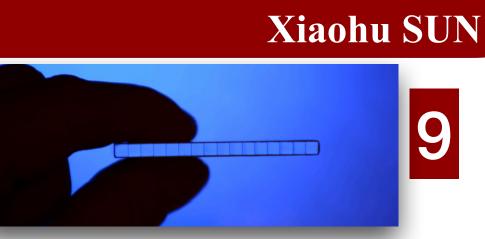
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- Each sensor module contains 16 LYSO:Ce crystals placed in parallel, with a cross-section of  $\sim 3 \times 3 \text{ mm}^2$ 
  - Fast rising (~100 ps) and decay time (~40 ns)
  - High light output: 40000 gamma/MeV
  - Radiation hard, proven up to 50 kGy with gamma radiation from <sup>60</sup>Co and  $3 \times 10^{14} \text{ N}_{eq}/\text{cm}^2$  with 1 MeV neutron
  - Mature technology in industry (PET)



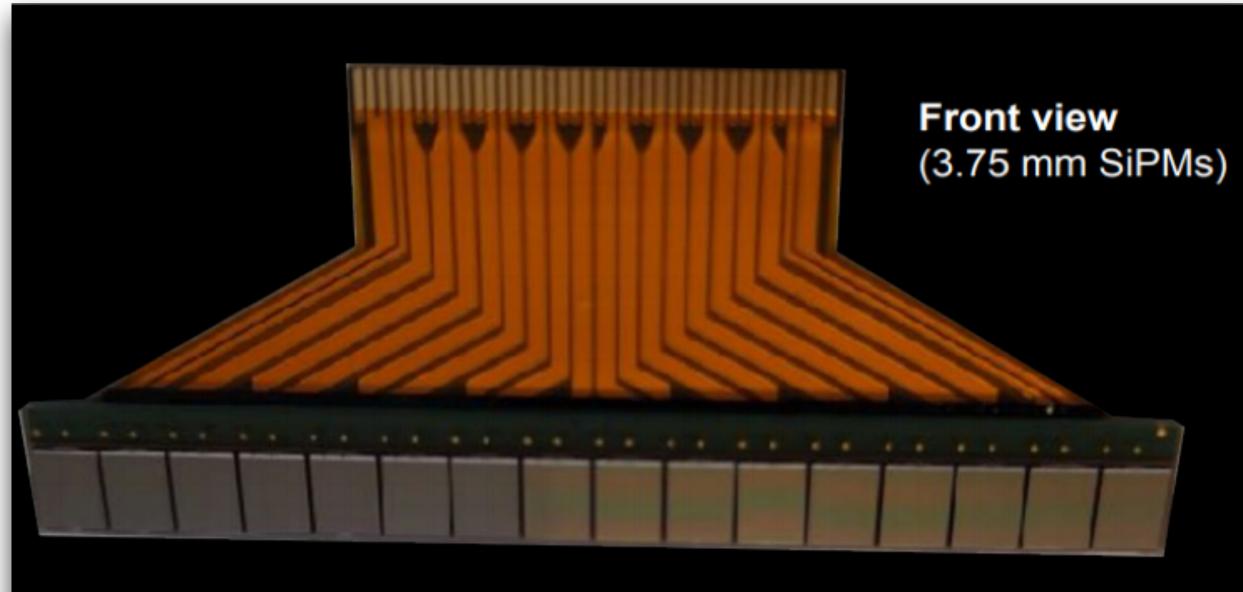
Type	t (mm)	<b>Eta</b>
1	3.75	0-0.7
2	3	0.7 - 1.1
3	2.4	1.1 - 1.5
L=56.2 mm. w=3.12 mm		

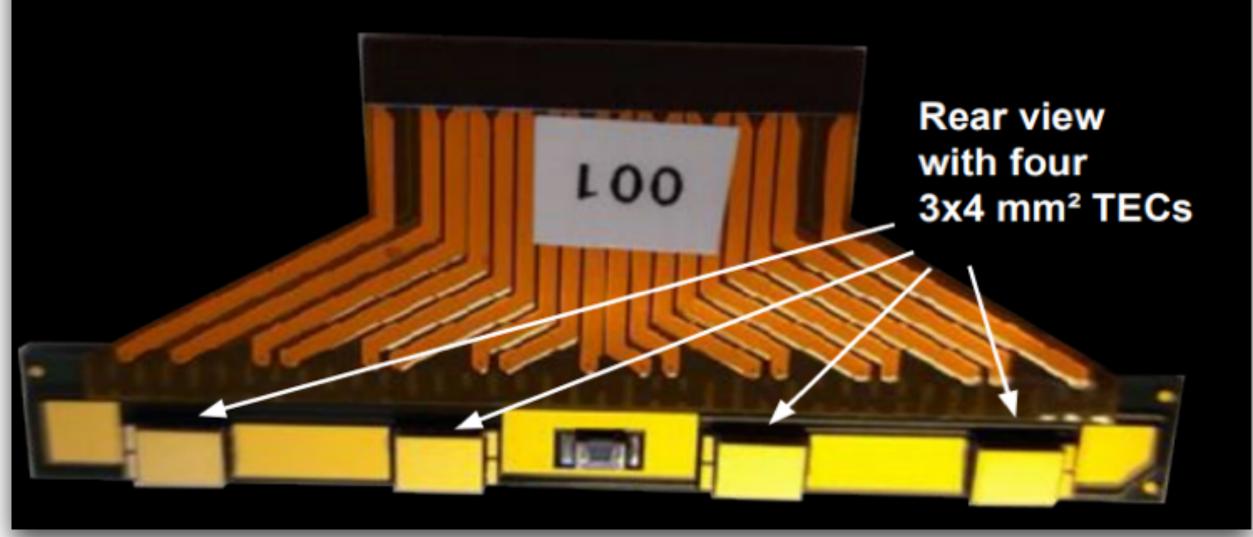






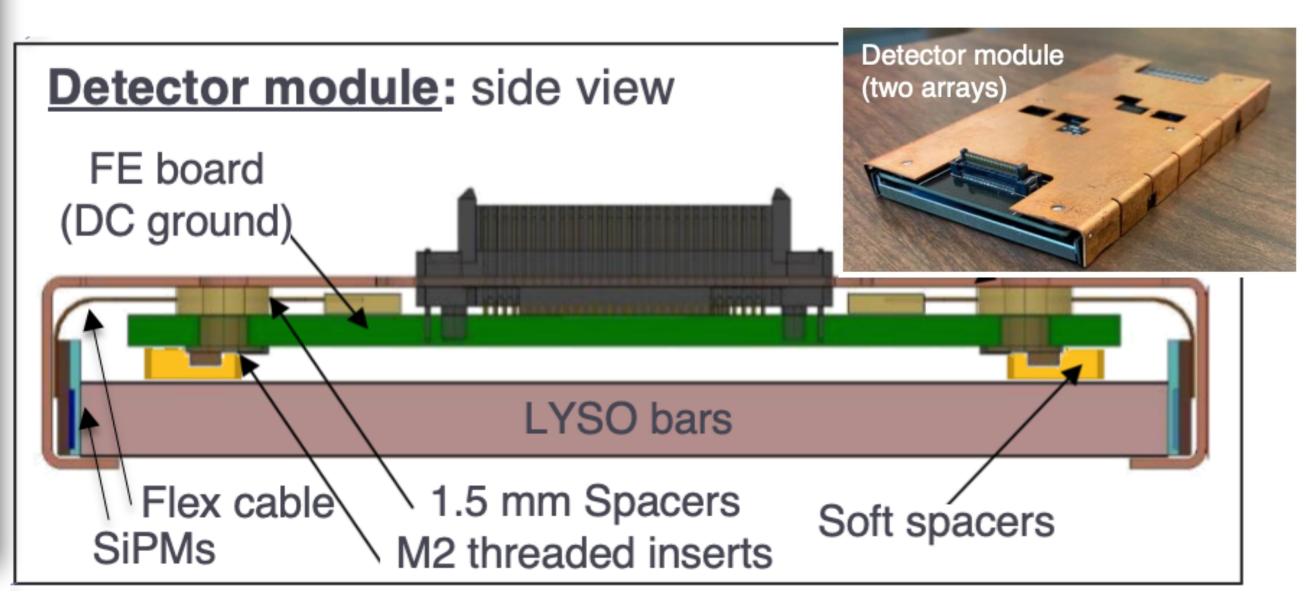
### Sensor: SiPM





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- Each sensor module contains 32 SiPM, with the effective area of  $\sim 3 \times 3 \text{ mm}^2$ 
  - Compact in size, insensible to magnetic fields
  - Fast recover time < 10 ns, high gain  $\times 10^{5}$
  - PDE@LYSO emission peak 20-40%
  - Cooled by the cooling chamber of the tracker and further by TECs 3x4 mm<sup>2</sup> x 0.9 mm







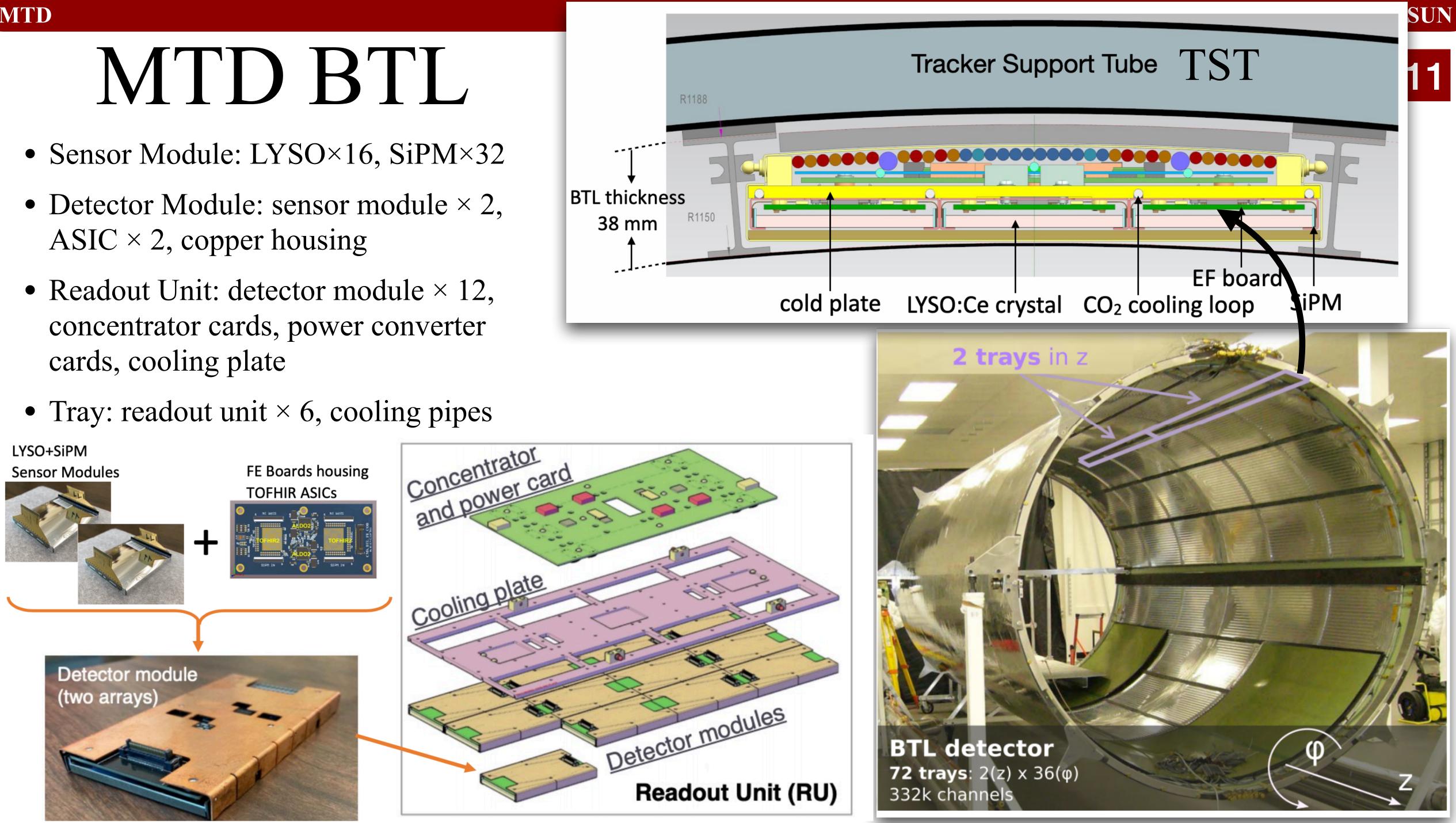


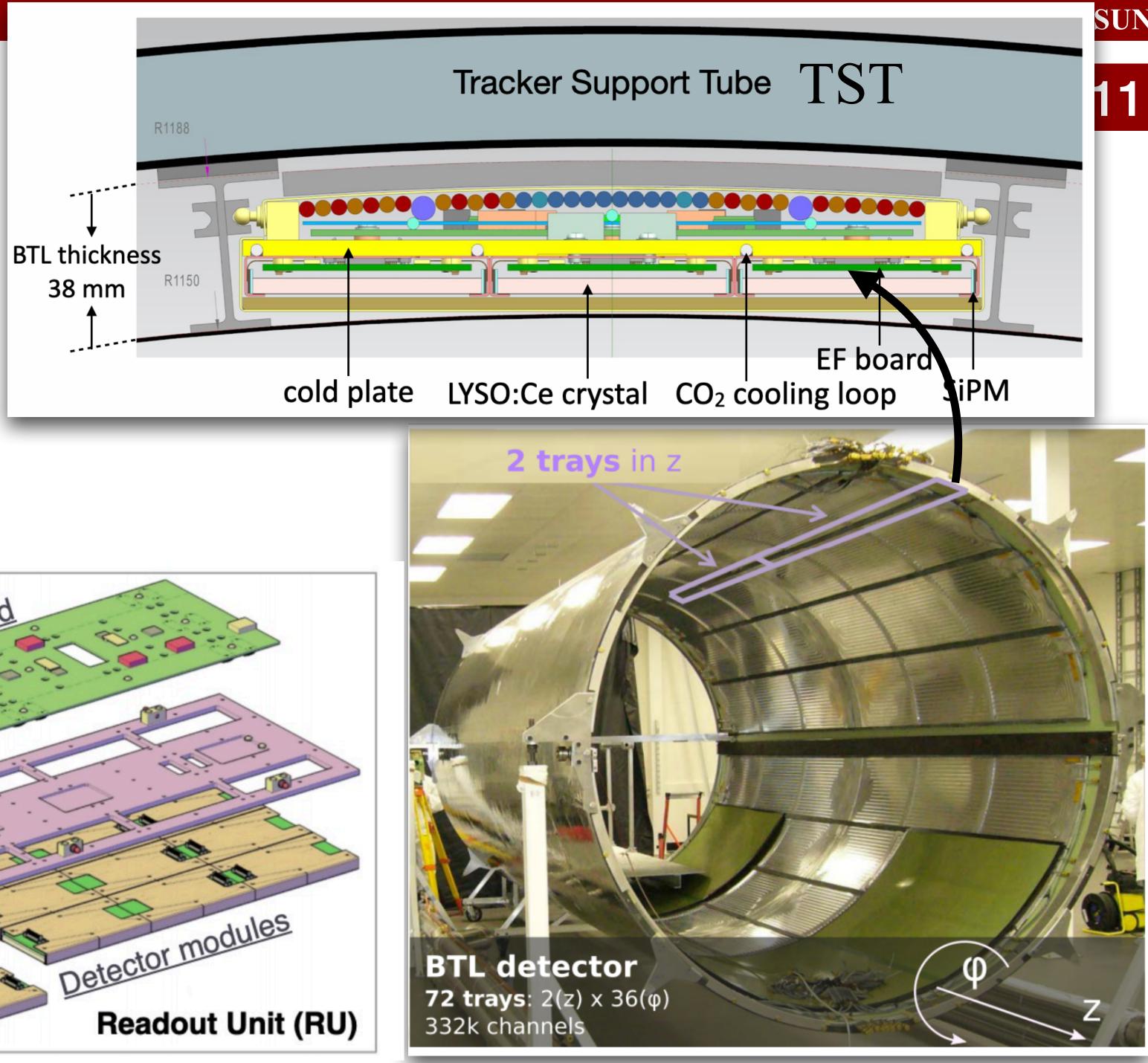




### MTD

- ASIC  $\times$  2, copper housing
- concentrator cards, power converter cards, cooling plate



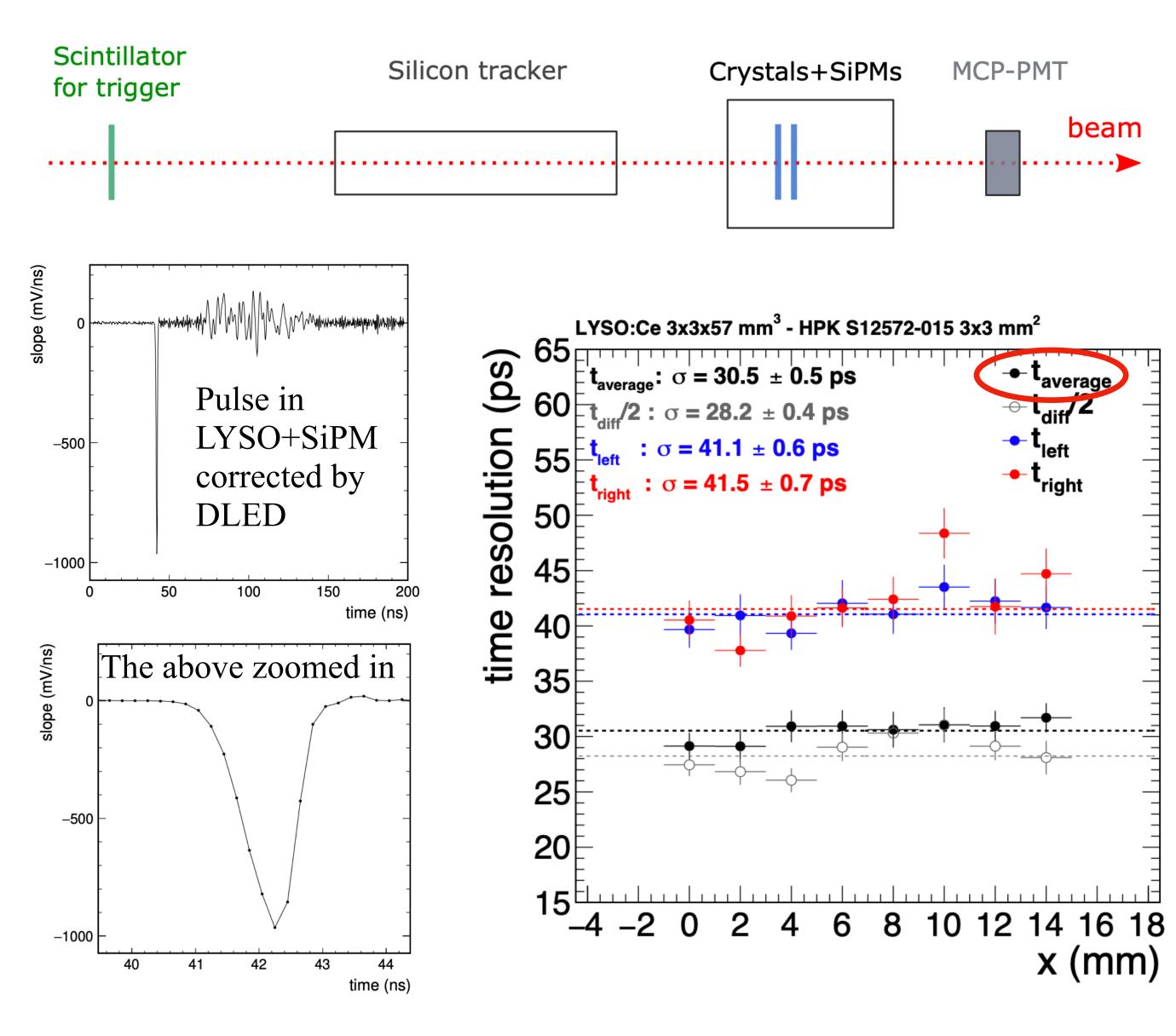




- Prototype was tested with 120 GeV proton beam @ FNAL
  - Silicon tracker to identify the position
  - MCP-PMT used as a time reference
- Pulse in LYSO+SiPM corrected by the differential leading edge discriminator (DLED) method
- A time resolution of 30 ps independent of the incoming position can be reached

### **Peking University**

### Test beam



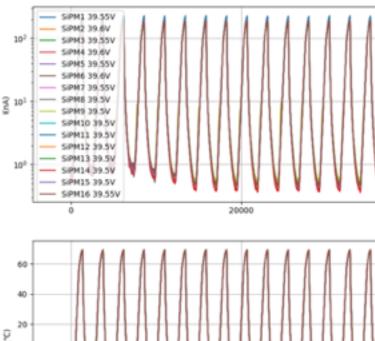


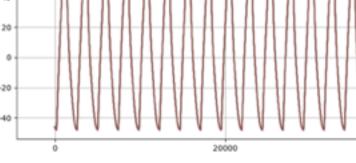












# Elocal activities 13

Many actives are ongoing locally, including

- SiPM tests and R&D
- The coupling between LYSO and SiPM
- Assembly preparation
- QA/QC design

• Combining the efforts from 北京 大学,清华大学 and 北京航空航 天大学, we are building an assembly center at Beijing











## Summary

- MTD is special timing detector that is designed to deal with ~200 pileup vertices and to keep the physics sensitivity of CMS during HL-LHC operations
  - First time on CMS to have a dedicated timing detector and to reach a time resolution of 30 ps, very promising
- Sensor design with LYSO+SiPM for the MTD barrel is proven to reach the expected time resolution using radiation sources and test beams
  - These two sensor materials have mature technology and can be provided by the industry
- R&D is close to the end and the assembly is going to start in middle 2023







